

Appl. No. 09/746,960
Amdt. dated September 26, 2003
Reply to Office Action of July 30, 2003

Amendments to the Specification:

Please replace paragraph [0394] in the substitute specification filed April 27, 2001 with the following amended paragraph:

[0394] **Figure 5F** shows an exemplary, overcoated, freestanding, resilient contact structure 530 (compare the shaped wire 202 of **Figure 2E**) extending from a terminal 512 (compare 212) on a substrate. In this illustration, the distal end (tip) 530b of the contact structure 530 (without any force applied thereto, and shown as a solid line) is at a position "A" above the surface of the substrate. A force, indicated by the arrow "F", applied axially (towards the substrate 508) through the distal end of the resilient contact structure 530, will cause the resilient contact structure 530 to deflect - as shown in dashed lines -so that the tip of the contact structure (with the force applied thereto) is at a position "B" above the surface of the substrate. The deflecting force "F" will result from urging the substrate 508 which may, itself, be an electronic component, against another electronic component 511 to effect an interconnection, via the resilient contact structure, between the two electronic components, or vice-versa.